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CUSTOMER CKR001

SAMPLE CODE SE12864WRF-022-H-Q

MASS PRODUCTION CODE PE12864WRF-022-H-Q

SAMPLE VERSION 01

SPECIFICATIONS EDITION 002

DRAWING NO. (Ver.) JLMD- PE12864WRF-022-H-Q_001

PACKAGING NO. (Ver.) JPKG- PE12864WRF-022-H-Q_001

Customer Approved

Date:

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璐	

Approved	Cnecked	Designer
閆偉	劉進	陳璐

- Preliminary specification for design input
- Specification for sample approval

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
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04/18/2018	01	002	New Sample	-	陳璐
					2//
				<i></i>	

Total: 32 Page



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
- 2.4 Display Command

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix: 1. LCM Drawing

2. Packaging



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	128 * 64 Dots
LCD Type	FSTN, Positive, Transflective
Driver Condition	LCD Module : 1/65 Duty, 1/9 Bias
Viewing Direction	6 O'clock
Weight	27.3g
Interface	8 bits parallel data input
Controller / Driver IC	ST7565S-G
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web site :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit					
Outline Dimension	93.7 (W) * 53.0 (L) * 4.5(H)MAX	mm					
Viewing Area	70.7 (L) * 38.8 (W)	mm					
Active Area	66.52 (L) * 33.24 (W)	mm					
Dot Size	0.48 (L) * 0.48 (W)	mm					
Dot Pitch	0.52 (L) * 0.52 (W)	mm					

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V _{DD}	-	-0.3	+5.0	V
LCD Driver Supply Voltage	V _{DD} -V ₅	1	-0.3	+18.0	V
Input Voltage	V _{IN}	-	-0.3	V _{DD} +0.3	
Operating Temperature	Тор	1	-20	+70	°C
Storage Temperature	Tst	-	-30	+80	°C
Storage Humidity	H _D	Ta < 40 °C	20	90	%RH



1.4 DC Electrical Characteristics

VDD = 3.3V, VSS = 0V, Ta = 25° C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V_{DD}	-	3.0	3.3	3.6	V
"H" Input Voltage	ViH	-	0.8V _{DD}	_	V _{DD}	V
"L" Input Voltage	VIL	-	Vss	J	0.2V _{DD}	V
"H" Output Voltage	Vон	-	0.8V _{DD}	-	V _{DD}	V
"L" Output Voltage	Vol	-	Vss	-	0.2V _{DD}	V
Supply Current	IDD	VDD= 3.3V; Vop= 10.0 V; *1		0.6	1.5	mA
		-20°C	10.0	10.2	10.4	
LCM Driver Voltage	Vop	+25°C	9.8	10.0	10.2	V
		+70°C	9.5	9.7	9.9	

Note: *1. The Maximum current display.



^{*2.} The Vop test point is V_{DD} - V_5 .



1.5 Optical Characteristics

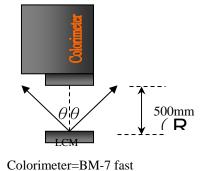
LCD Panel: 1/65 Duty, 1/9 Bias, VLCD = 10.0V, Ta = 25°C

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr		-	110	165	me	Note 2
Response fille	Fall	tf	_	-	226	339	ms	NOIE 2
	Rear	⊖+		-	40	-		
	Front	θ-	C <u>></u> 2.0	-	40	-	-	Notes 1
Viewing angle range	Left	θL		-	45	-		
	Right	⊖R		-	45	-		
Contrast Ratio	•	CR	-	-	7.7	-	-	Note 3
Average Brightness (With LCD&B/L) *2		IV		100	140	1	cd/m ²	
CIE Color Coordinate		X	If=40mA	0.25	0.30	0.35		Note 4
(with LCD) *2		Y		0.26	0.31	0.36	-	
Uniformity *1		∆B	-	70	-	1	%	-

Note 4:

- 1 : △B=B(min) / B(max)*100%
- 2 : Measurement Condition for Optical Characteristics:
 - a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 0.2°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%

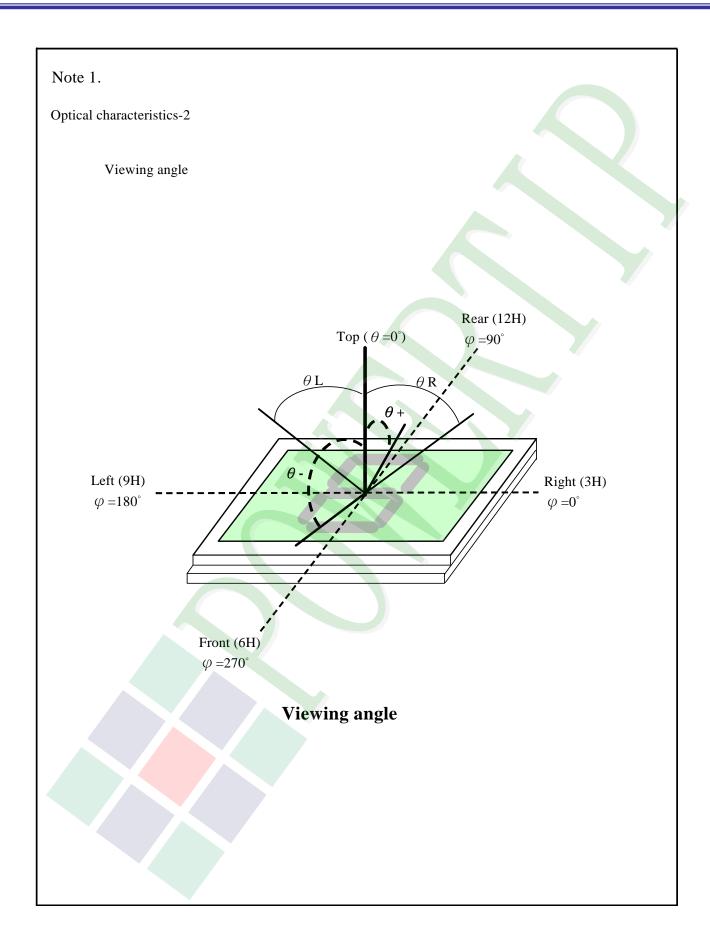




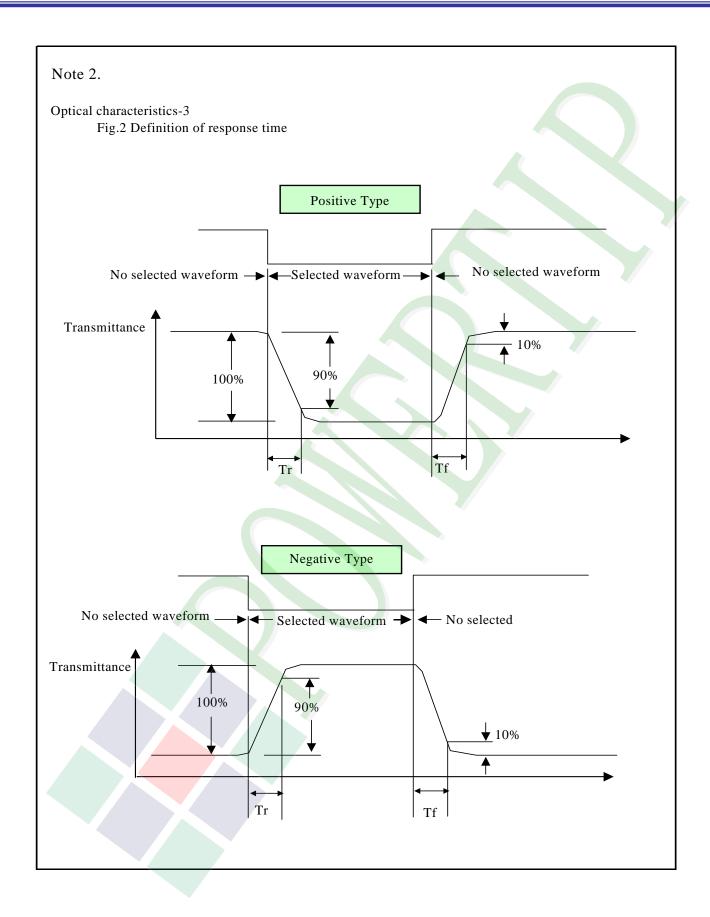
3: This value will be changed while mass production.

PE12864WRF-022-H-Q Page6 SAMPLE Ver.01 SPEC Edi.002









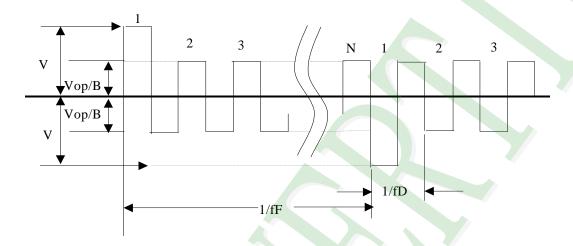


Electrical characteristics-2

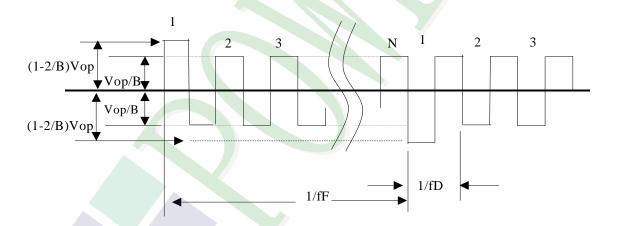
※2 Drive waveform

Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency N: Duty

(1) Selected waveform



(2) Non- Selected wave form

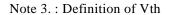


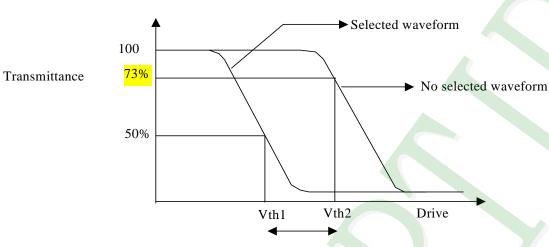
Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period

PE12864WRF-022-H-Q Page9 SAMPLE Ver.01 SPEC Edi.002







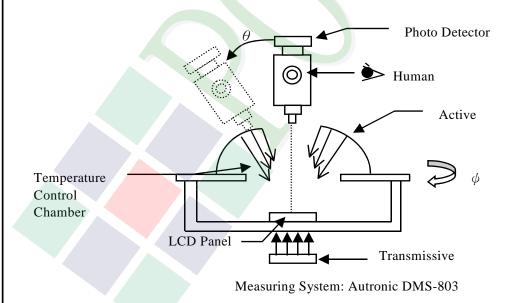
Active voltage range

	Vth1	Vth2
View direction	10°	40 °
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System



PE12864WRF-022-H-Q Page10 SAMPLE Ver.01



Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Peak forward current	IF		-	100	mA
Reverse Voltage	VR	Ta =25°ℂ	- 🔨	5	V
Power dissipation	Pd		-	380	mW

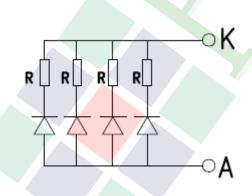
Electrical / Optical Characteristics

Ta =25°C

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		3.0	3.3	3.8	٧
Average Brightness (Without LCD) *1	IV	IF= 40 mA	600	720	-	cd/m ²
CIE Color Coordinate	Х	1F = 40 IIIA	0.25	_/-	0.32	
(without LCD)	Υ		0.25	-	0.32	-
Uniformity *2	∆B		70	-	-	
Color			White			

^{*1} This value will be changed while mass production. *2 : \triangle B=B(min) / B(max)*100%

Circuit diagram





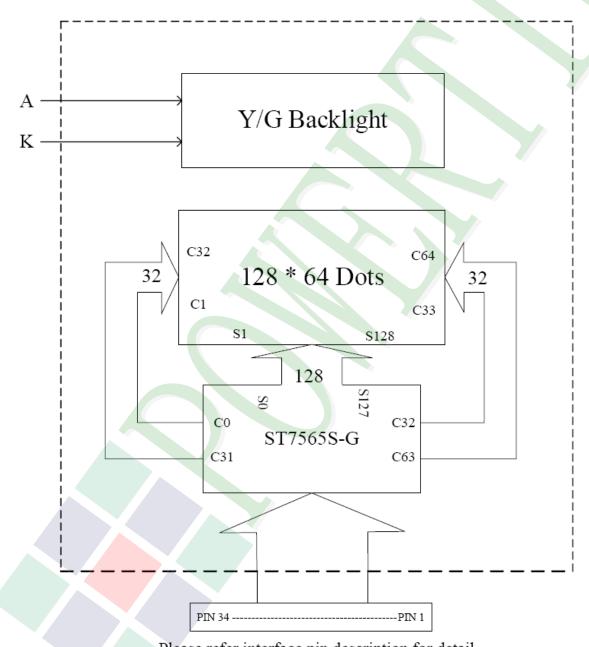
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



Please refer interface pin description for detail



2.2 Interface Pin Description

Pin No.		Function
	,	This is the chip select signal. When /CS1="L", then the chip select becomes
1	/CS1	active, and data/command I/O is enable.
2	/RES	When /RES is set to "L", the setting are initialized.
		This is connect to the least significant bit of the normal MPU address bus, and it
3	A0	determines whether the data bits are data or a command.
3	Au	A0="H": Indicates that D0 to D7 are display data.
		A0="L": Indicates that D0 to D7 are control data.
		When connected to an 8080 MPU, this is active LOW.
		(R/W) This terminal connects to the 8080 MPU /WR signal. The signals on the
	/WR	data bus are latched at the rising edge of the /WR signal.
4	(R/W)	When connected to a 6800 Series MPU:
	()	This is the read/write control signal input terminal.
		When R/W = "H": Read.
		When R/W = "L": Write.
		When connected to an 8080 MPU, this is active LOW.
	/RD	(E) This pin is connected to the /RD signal of the 8080 MPU, and the ST7565S
5	(E)	series data bus is in an output status when this signal is "L".
	,	When connected to a 6800 Series MPU, this is active HIGH.
		This is the 6800 Series MPU enable clock input terminal.
6	D0	
7	D1	
8	D2	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus.
9	D3	When the serial interface is selected (P/S="L"):
10	D4	D7:serial data input (SI);D6:the serial clock input(SCL).
11	D5	D0 to D5 are set to high impedance.
12	D6	When the chip select is not active, D0 to D7 are set to high impedance.
13	D7	
14	VDD	Shared with the MPU power supply terminal VDD.(3.3V).
15	VSS	This is a 0V terminal connected to the system GND
16	VOUT	DC/DC voltage converter. Connect a capacitor between this terminal and VSS.



17	CAP5-	DC/DC voltage converter. Connect a capacitor between this terminal and the
	0/11 0	CAP1+ terminal.
18	CAP3-	DC/DC voltage converter. Connect a capacitor between this terminal and the
10	0/11 0	CAP1+ terminal.
19	CAP1+	DC/DC voltage converter. Connect a capacitor between this terminal and the
19	CALIT	CAP1- terminal.
20	CAP1-	DC/DC voltage converter. Connect a capacitor between this terminal and the
20	CAP 1-	CAP1+ terminal.
21	CAP2+	DC/DC voltage converter. Connect a capacitor between this terminal and the
21	CAFZI	CAP2- terminal.
22	CAP2-	DC/DC voltage converter. Connect a capacitor between this terminal and the
22	UAFZ-	CAP2+ terminal.
23	CAP4-	DC/DC voltage converter. Connect a capacitor between this terminal and the
23	CAP4-	CAP2+ terminal.
24	VRS	This is the internal-output VREG power supply for the LCD power supply
24	VIXO	voltage regulator.
25	V1	This is a multi-level power supply for the liquid crystal drive. The voltage Supply
26	V2	applied is determined by the liquid crystal cell, and is changed through the use
		of a resistive voltage divided or through changing the impedance using an op.
27	V3	amp. Voltage levels are determined based on VDD, and must maintain the
28	V4	relative magnitudes shown below.
		$VDD (= V0) \ge V1 \ge V2 \ge V3 \ge V4 \ge V5$
29	V5	When the power supply turns ON, the internal power supply circuits produce the
20		V1 to V4 voltages shown below. The voltage settings are selected using the
		LCD bias set command.
		Output voltage regulator terminal. Provides the voltage between VDD and V5
30	VR	through a resistive voltage divider.
		IRS = "L": the V5 voltage regulator internal resistors are not used.
		IRS = "H": the V5 voltage regulator internal resistors are used.
		This is the MPU interface switch terminal.
31	C86	C86 = "H": 6800 Series MPU interface.
		C86 = "L": 8080 MPU interface.



	1									
		This is the parallel data input/serial data input switch terminal.								
		P/S = "H": Parallel data input.								
		P/S = "L": Serial data input.								
		The following applies depending on the P/S status:								
32	P/S	P/S Data/Command Data Read/Write Serial Clock								
		"H" A0 D0 to D7 /RD, /WR X								
		"L" A0 SI (D7) Write only SCL (D6)								
		When P/S = "L", D0 to D5 fixed "H".								
		/RD (E) and /WR (R/W) are fixed to either "H" or "L".								
		With serial data input, It is impossible read data from RAM.								
		This is the power control terminal for the power supply circuit for liquid crystal								
22	/LIDM	drive.								
33	/HPM	/HPM = "H": Normal mode								
		/HPM = "L": High power mode								
		This terminal selects the resistors for the V5 voltage level adjustment.								
		IRS = "H": Use the internal resistors								
34	IRS	IRS = "L": Do not use the internal resistors. The V5 voltage level is regulated by								
		an								
		external resistive voltage divider attached to the VR terminal								

	Б.	Symbol	Function
,	BL Pin No.	Α	Power supply for LED Backlight Anode input(VF=2.2V,IF=100mA)
ľ		K	Power supply for LED Backlight Cathode input(0V)

PE12864WRF-022-H-Q Page15 SAMPLE Ver.01 SPEC Edi.002



2.2.1 Refer Initial Code

White com(0xe2); Internal Reset

White_com(0xa2); LCD BIAS SET (0:1/9)

White_com(0xa0); ADC SELECT (0:NORMAL)

White_com(0xc8); COMMON OUTPUT MODE SELECT (0:NORMAL)

White_com(0xa6); DISPLAY NORMAL/REVERSE (0:NORMAL)

White_com(0xa4); DISPLAY ALL POINTS (0:NORMAL)

White com(0x2f); POWER CONTROL SET

White com(0x25); V5 VOLTAGE REGULATOR INTERNAL

White com(0x81); ELECTRONIC VOLUME MODE SET

White_com(0xf8); BOOSTER RATIO SET

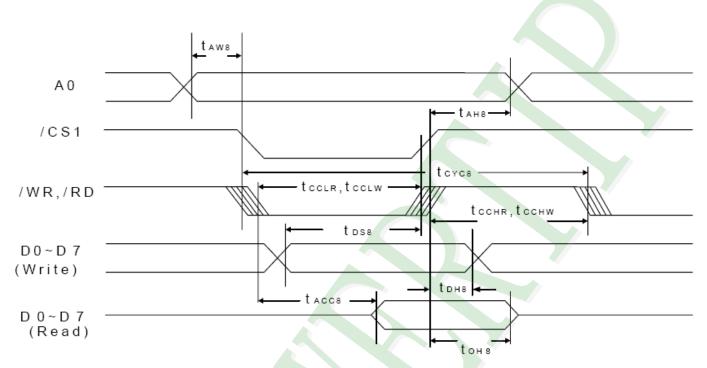
White com(0x00); 4X

White_com(0x5f); LCD DISPLAY ON



2.3 Timing Characteristics

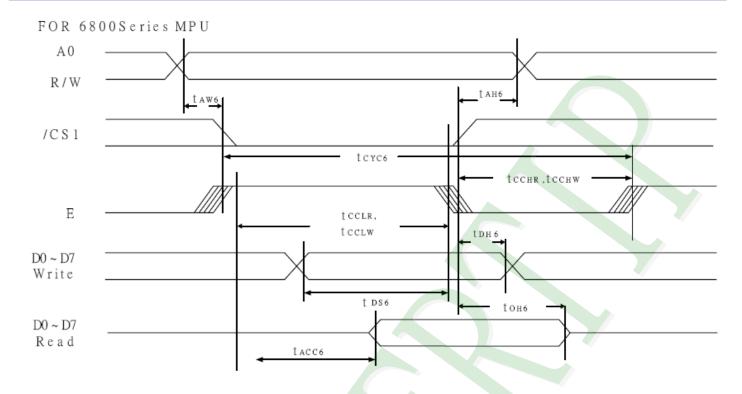
FOR 8080 Series MPU



Item	Signal	Symbol	Condition	Rat	ing	Units
				Min.	Max.	
Address hold time	A0	t _{AH8}		0	-	
Address setup time		t _{AW8}		0	-	
System cycle time		t _{CYC8}		240	-	
Enable L pulse width (WRITE)	WR	t _{CCLW8}		80	-	
Enable H pulse width (WRITE)		t _{CCHW8}		80	-	
Enable L pulse width (READ)	RD	t _{CCLR8}		140	-	ns
Enable H pulse width (READ)		t _{CCHR8}		80		
WRITE Data setup time	D0	→ t _{DS8}		40	-	
WRITE Address hold time	to	t _{DH8}		0	-	
READ access time	D7	t _{ACC8}	C _L =100pF	-	70	
READ Output disable time		t _{OH8}	C _L =100pF	5	50	

PE12864WRF-022-H-Q Page17

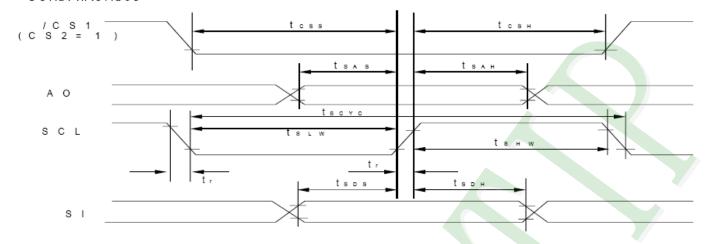




Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	t _{AH6}		0	-	
Address setup time		t _{AW6}		0	-	
System cycle time		t _{CYC6}		240	-	
Enable L pulse width (WRITE)	WR	t _{EWLW}		80	-	
Enable H pulse width (WRITE)		t _{EWHW8}		80	-	
Enable L pulse width (READ)	RD	t _{EWLR8}		80	-	ns
Enable H pulse width (READ)		t _{EWHR}		140		
WRITE Data setup time	D0	t _{DS6}		40	-	
WRITE Address hold time	to	t _{DH6}		0	-	
READ access time	D7	t _{ACC6}	C _L =100pF	-	70	
READ Output disable time		t _{OH6}	C _L =100pF	5	50	

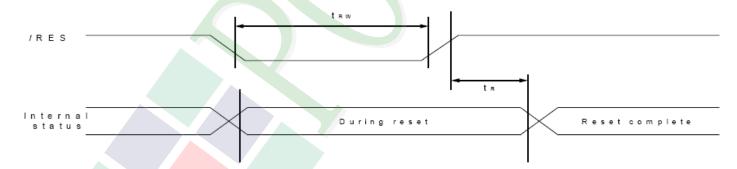


S e ria I In te rfa c e



Itama	Ciamal	Cymahal	Condition	Rat	Units		
Item	Signal	Symbol	Condition	Min	Max	Offics	
Serial Clock Period		T _{SCYC}		100	4/		
SCL"H" pulse with	SCL	Tshw	-	50	-		
SCL"L" pulse with		T _{SLW}	-	50	-		
Address setup time	A0	T _{SAS}	-	20	-		
Address hold time	70	T _{SAH}	-	10	-	ns	
Data setup time	SI	T_{SDS}	-	20	-		
Data hold time		T _{SDH}	-	10	-		
CS-SCL time	CS	T _{CSS}	/	40	-		
CS-SCL time	03	T _{CSH}	-	40	-		

Reset Timing



Item	Cianal	Symbol	Condition		Units		
item	Signal	Symbol	Condition	Min	Тур	Max	Units
Reset time	-	t _R		-	-	1.0	μs
Reset "L" pulse width	RES	t _{RW}	-	1.0	-	-	μs



2.4 Display Command

Instruction	RS	RW	D7	D6	D5	D4	D3	D2	D1	D0	Description
Display ON/OFF	0	0	1	0	1	0	1	1	1	0/1	Turn on/off LCD panel.
Display start line set	0	0	0	1		Displ	ay sta	ırt ado	dress		Specify DDRAM line for COM0
Page address set	0	0	1	0	1	1	P	age a	ddres	ss	Set page address
Set column address MSB	0	0	0	0	0	1	Y7	Y6	Y5	Y4	Set column address MSB
Set column address LSB	0	0	0	0	0	0	Y3	Y2	Y1	Y0	Set column address LSB
Read status	0	1	BUSY	ADC	ON/OFF	RESET	0	0	0	0	Read the internal status
Write display data	1	0				Write	data				Write data into DDRAM
Read display data	1	1		Read data				Read data from DDRAM			
ADC select	0	0	1	0	1	0	0	0	0	0/1	Select SEG output directional
Display normal/reverse	0	0	1	0	1	0	0	1	1	0/1	Select normal/reverse display
Display all points ON/OFF	0	0	1	0	1	0	0	1	0	0/1	Select normal/entire display ON
LCD bias select	0	0	1	0	1	0	0	0	1	0/1	Select LCD bias
Read/modify/write	0	0	1	1	1	0	0	0	0	0	Column address Increment
End	0	0	1	1	1	0	1	1	1	0	Clear read/modify/write
Reset	0	0	1	1	1	0	0	0	1	0	Initialize the internal functions
Common output Mode select	0	0	1	1	0	0	0/1	х	Х	х	Select COM output scan direction
Power control	0	0	0	0	1	0	1	0/1	0/1	0/1	Control power circuit operation
V5 voltage regulator internal resistor ratio set	0	0	0	0	1	0	0 Resistor ratio			ratio	Select internal resistance ratio of the regulator resistor



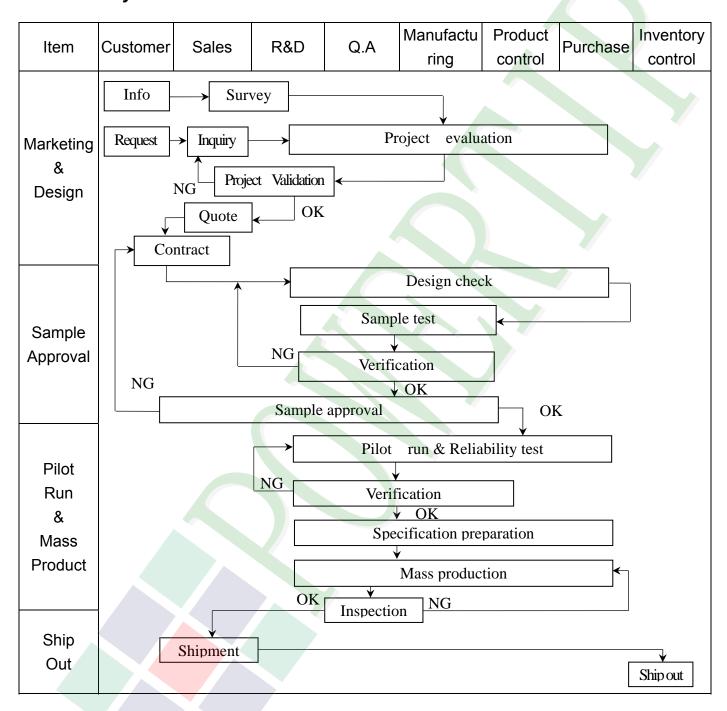
Instruction	RS	RW	D7	D6	D5	D4	D3	D2	D1	D0	Description
Electronic volume mode set	0	0	1	0	0	0	0	0	0	1	Set reference voltage mode
Electronic volume regulator set	0	0	х	х	Е	lectro	nic vo	olume	value		Set reference voltage register
Static indicator ON/OFF	0	0	1	0	1	0	1	1	0	0/1	Set static indicator mode
Static indicator register set	0	0	х	х	х	х	х	x	Мс	de	Set the flashing mode
Boosting ratio set	0	0	1	1	1	1	1	0	0	0	Select boosting
Boosting ratio set	0	0	*	*	*	*	*	*	Mo	de	ratio
Power save	-	-	-	-	-	4	·		-	-	Display OFF and Display all point ON compound command
NOP	0	0	1	1	1	0	0	0	1	1	N0n operation command



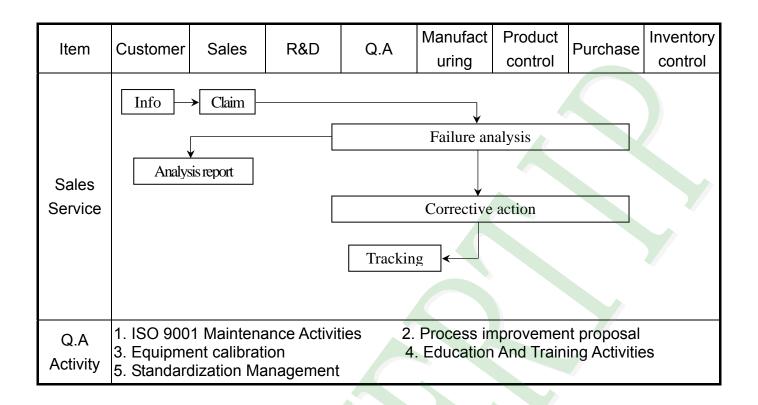


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

◆Scope : The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).

◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge \ MIL-STD \ Powertip Tester \ Sample

◆Defect Level: Major Defect AQL: 0, 4; Minor Defect: AQL: 1, 5.

♦OUT Going Defect Level : Sampling .

◆Manner of appearance test:

(1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.

(2). Standard of inspection ∶ (Unit ∶ mm)

(3). The test direction is base on about around 45° of vertical line. (Fig. 1)

(4). Definition of area . (Fig. 2)

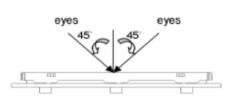


Fig.1

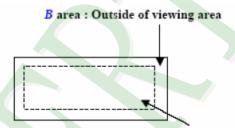


Fig. 2 🔏 area : viewing area

Specification:

▼ Spc	ecilication:		
NO	Item	Criterion	Level
		1. 1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1. 2 Mixed production types.	Major
		1. 3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3. 1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
		4. 2 No function or no display.	Major
04	Electrical Testing	4. 3 Output data is error.	Major
		4. 4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major

PE12864WRF-022-H-Q Page24 SAMPLE Ver.01



◆Specification For Monotype and Color STN:

NO	Item	Criterion										
	Black or white dot \ scratch \ contamination	 5. 1 Round type: 5. 1. 1 display only: • White and black spots on 4 white or black spots pr • Densely spaced: NO more 	esent.				Y					
	Round type	5. 1. 2 Non-display : Dimension (diameter : Φ)	Dimension Acceptance (Q'ty)									
0.5	$+$ $ _{X}$ $ _{Y}$	$\Phi \le 0.10$ $0.10 < \Phi \le 0.20$		ept no dense		7 /						
$\Phi = (x+y)/2$		$0.20 < \Phi \leq 0.30$ Total quantity		2 4			Minor					
		5. 1. 3 Line type: Dimension		Accon	tanc	e (Q'ty)						
	Line type	Length (L) Width (W)		A area	тапс	B area						
	↓	W ≦		Accept no dei	ıse	2						
	→ L ←	$L \le 3.0$ $0.03 < W \le 0.05$ $L \le 2.5$ $0.05 < W \le 0.05$	0. 05	4		Ignore						
		w >0										
		Dimension (diameter : Φ)		Acceptano A area	e (Q							
		$\Phi \leq 0.20$		cept no dense		B area						
06	Polarizer	$0.20 < \Phi \le 0.50$	A	3	\dashv							
00	Bubble	$0.50 < \Phi \le 1.00$	2			Ignore	Minor					
		Φ > 1.00		0								
		Total quantity		4								



◆Specification For Monotype and Color STN:

NO	Item	Criterion		Level
		Symbols: X: The length of crack Y: Z: The thickness of crack W: t: The thickness of glass a:	LCD side length	
	7.1 General glass chip: 7.1.1 Chip on panel surface and crack between panels:			
		Y Z	Z X	
07	The crack of glass	SP Y	SP [NG]	Minor
	Seal width X Z↓			
		X Y	z	
		≦ a Crack can't enter viewing area	≦1/2 t	
	X	≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	



Specification For Monotype and Color STN:

NO	Item	Criterion	
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 7. 1. 2 Corner crack:	
		X Y Z	
		≤1/5 a Crack can't enter viewing area Z ≤ 1/2 t	
	The crack of glass	$\leq 1/5$ a Crack can't exceed the half of SP width. 1/2 t < Z ≤ 2 t	
07		7.2 Protrusion over terminal:	Minor
		7.2.1 Chip on electrode pad:	
		X X Y Z	
		W X	
		X Y Z	
		Front \leq a \leq 1/2 W \leq t	
		Back Neglect	



◆Specification For Monotype and Color STN:

NO	Item	Criterion Criterion		
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length		
		7. 2. 2 Non-conductive portion:		
07	The crack of glass	 X Y Z ≤1/3 a ≤W ≤t O If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 7. 2, 3 Glass remain : 	Minor	
		$\begin{array}{c cccc} X & Y & Z \\ \leq a & \leq 1/3 \text{ W} & \leq t \end{array}$		



◆Specification For Monotype and Color STN:

NO	Item	Criterion	Level
08	Backlight elements	8. 1 Backlight can't work normally.	Major
		8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
09	General appearance	9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
		9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1. 5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

4.1	Reliability lest Collution (vel.bul)				
NO.	TEST ITEM	TEST CONDITION			
1	High Temperature	Keep in 80°C ±2°C 240hrs			
•	Storage Test	Surrounding temperatu		age at normal condition	n 4hrs.
2	Low Temperature	Keep in -30°C ±2°C 240hrs			
	Storage Test	Surrounding temperature, then storage at normal condition 4hrs.			
3	High Temperature /	Keep in +60°C /90% R.H duration for 240hrs			
	High Humidity	Surrounding temperature, then storage at normal condition 4hrs.			
	Storage Test	(Excluding the polarizer)			
		$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$			
4	Temperature Cycling Storage Test	(30mins) (5mins) (5mins)			
•		20 Cycle			
		Surrounding temperature, then storage at normal condition 4hrs.			
	ESD Test	Air Discharge:		Contact Discharge:	
		Apply 2 KV with 5 time	\mathbf{s}	Apply 250 V with 5 tin	nes
		Discharge for each polar		lischarge for each pola	rity +/-
		1. Temperature ambiance : 15°C ~35°C			
5		2. Humidity relative : 3			
		3. Energy Storage Capacitance(Cs+Cd): 150pF±10%			
		 4. Discharge Resistance(Rd): 330 Ω±10% 5. Discharge, mode of operation: 			
			_	ooggive dischauses et	loost 1 soo)
		Single Discharge (time		G	least 1 sec)
		(Tolerance if the output		,	
	Vibration Test	1. Sine wave 10∼55 H		_	
6	(Packaged)	2. The amplitude of vib			
		3. Each direction (X >	Y \ Z) dura	tion for 2 Hrs	7
		Packing V	Veight (Kg)	Drop Height (cm)	
	Drop Test (Packaged)	0	~ 45.4	122	
		45. 4	~ 90.8	76	
7		90.8	~ 454	61	
		0ver	454	46	
		D D: :: 344	10.3	/0.11	1
		Drop Direction: **1 cor	ner / 3 edges	s / b sides each Itime	

PE12864WRF-022-H-Q SAMPLE Ver.01 Page30



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution!(LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
 - Therefore, the touch needs to be thoroughly tested inside the target application.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

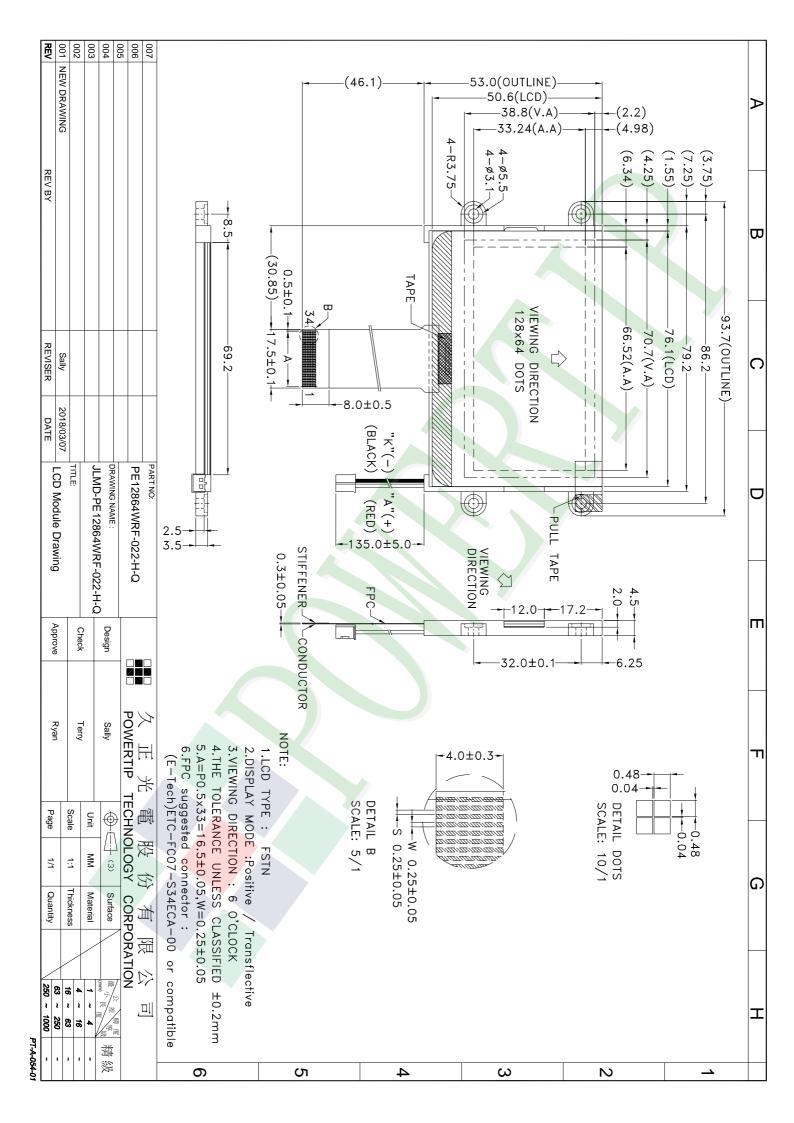
- 5.4.1 Applicable warrant period

 The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in



nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life





Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Ryan Sally Terry Documents NO. JPKG-PE12864WRF-022-H-Q (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) Item Dimensions (mm) 1Pcs Weight Total Weight No. Model Quantity 成品 (LCM) PE12864WRF-022-H-Q 93.7 X 53.0 144 1 0.027 3.888 2 多層薄膜(1)POF 6 19"X350X0.015 OTFILM0BA03ABA 3 TRAY 盤 (2)Tray TY12806422TZBA 352 X 260 X 16.8 24 2.4 0.1 4 内盒(3)Product Box BX36627063ABBA 366 X 270 X 66 0.2692 6 1.6152 OTPLB00PL08ABA 5 550 X 393 X 20 0.0284 2 0.0568 保利龍板(4)Polylon board 6 外紙箱(5)Carton BX57041027CCBA 570 X 410 X 265 1.4208 1.4208 7 8 9 2. 一整箱總重量 (Total LCD Weight in carton): 9.38 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): x no of tray 3 (1)LCM quantity per box: no per tray 8 24 24 x no of boxes 144 6 (2) Total LCM quantity in carton: quantity per box Use empty tray 空盤 (4)Polylon board (1) POF (2) Tray Put products into the tray (5) Carton Tray stacking (3)Product Box POWERTIP 記 特 事 項 (REMARK) Detail B Tray 2 Trav 1 4.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.